

Data Sheet November 2013

# 12 A, 200 V, Ultrafast Dual Diode

The RURD620CCS9A is an ultrafast dual diode with low forward voltage drop. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial application.

## **Ordering Information**

| PART NUMBER  | PACKAGE   | BRAND  |
|--------------|-----------|--------|
| RURD620CCS9A | TO-252-3L | UR620C |

NOTE: When ordering, use the entire part number. Add the suffix, 9A, to obtain the TO-252 variant in tape and reel, i.e., RURD620CCS9A.

## Symbol



## Features

- Ultrafast Recovery t<sub>rr</sub> = 30 ns (@ I<sub>F</sub>= 6 A)
- Max Forward Voltage, V<sub>F</sub> = 1.0 V (@ T<sub>C</sub> = 25°C)
- Reverse Voltage, V<sub>RRM</sub> = 200 V
- · Avalanche Energy Rated
- RoHS Compliant

## **Applications**

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

## **Packaging**

**JEDEC TO-252** 



## Absolute Maximum Ratings (Per Leg) T<sub>C</sub> = 25°C Unless Otherwise Specified

|  | RURD620CCS9A | UNIT |
|--|--------------|------|
| Peak Repetitive Reverse Voltage          | 200          | V    |
| Working Peak Reverse Voltage             | 200          | V    |
| DC Blocking VoltageV <sub>R</sub>        | 200          | V    |
| Average Rectified Forward Current        | 6            | Α    |
| Repetitive Peak Surge Current            | 12           | Α    |
| Nonrepetitive Peak Surge Current         | 60           | Α    |
| Maximum Power Dissipation                | 45           | W    |
| Avalanche Energy (See Figures 10 and 11) | 10           | mJ   |
| Operating and Storage Temperature        | -65 to 175   | °C   |

**Electrical Specifications** (Per Leg)  $T_C = 25^{\circ}C$ , Unless Otherwise Specified

| SYMBOL          | TEST CONDITION   | MIN | TYP | MAX  | UNIT |
|-----------------|--|-----|-----|------|------|
| V <sub>F</sub>  | I <sub>F</sub> = 6 A                                     | -   | -   | 1.0  | V    |
|                 | $I_F = 6 \text{ A}, T_C = 150^{\circ}\text{C}$           | -   | -   | 0.83 | V    |
| I <sub>R</sub>  | V <sub>R</sub> = 200 V                                   | -   | -   | 100  | μΑ   |
|                 | $V_R = 200 \text{ V}, T_C = 150^{\circ}\text{C}$         | -   | -   | 500  | μΑ   |
| t <sub>rr</sub> | I <sub>F</sub> = 1 A, dI <sub>F</sub> /dt = 200 A/μs     | -   | -   | 25   | ns   |
|                 | $I_F = 6 \text{ A}, dI_F/dt = 200 \text{ A}/\mu\text{s}$ | -   | -   | 30   | ns   |
| t <sub>a</sub>  | I <sub>F</sub> = 6 A, dI <sub>F</sub> /dt = 200 A/μs     | -   | 13  | -    | ns   |
| t <sub>b</sub>  | I <sub>F</sub> = 6 A, dI <sub>F</sub> /dt = 200 A/μs     | -   | 6.5 | -    | ns   |
| Q <sub>rr</sub> | I <sub>F</sub> = 6 A, dI <sub>F</sub> /dt = 200 A/μs     | -   | 20  | -    | nC   |
| CJ              | V <sub>R</sub> = 10 V, I <sub>F</sub> = 0 A              | -   | 30  | -    | pF   |
| $R_{	heta JC}$  |  | -   | -   | 3.5  | °C/W |

## **DEFINITIONS**

 $V_F$  = Instantaneous forward voltage (pw = 300  $\mu$ s, D = 2%).

I<sub>R</sub> = Instantaneous reverse current.

 $T_{rr}$  = Reverse recovery time (See Figure 9), summation of  $t_a$  +  $t_b$ .

 $t_a$  = Time to reach peak reverse current (See Figure 9).

t<sub>b</sub> = Time from peak I<sub>RM</sub> to projected zero crossing of I<sub>RM</sub> based on a straight line from peak I<sub>RM</sub> through 25% of I<sub>RM</sub> (See Figure 9).

Q<sub>rr</sub> = Reverse recovery charge.

C<sub>J</sub> = Junction Capacitance.

 $R_{\theta JC}$  = Thermal resistance junction to case.

pw = Pulse width.

D = Duty cycle.

# **Typical Performance Curves**

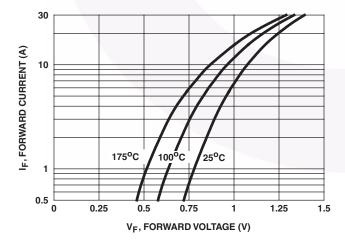


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

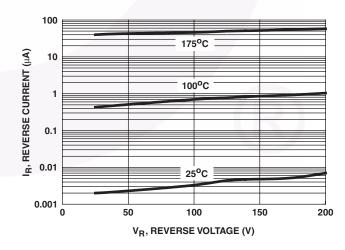


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

## Typical Performance Curves (Continued)

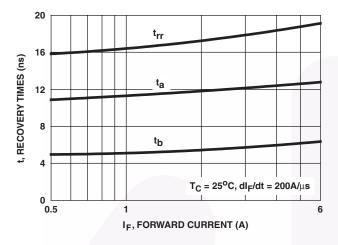


FIGURE 3.  $t_{rr}$ ,  $t_a$  AND  $t_b$  CURVES vs FORWARD CURRENT

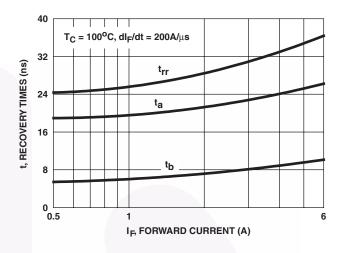


FIGURE 4. t<sub>rr</sub>, t<sub>a</sub> AND t<sub>b</sub> CURVES vs FORWARD CURRENT

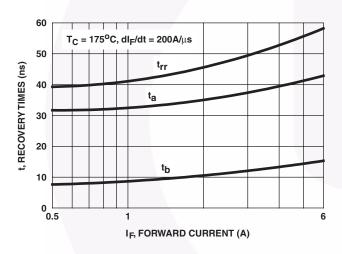


FIGURE 5.  $t_{rr}$ ,  $t_a$  AND  $t_b$  CURVES vs FORWARD CURRENT

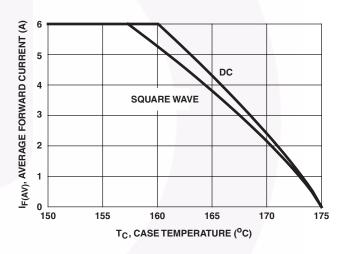


FIGURE 6. CURRENT DERATING CURVE

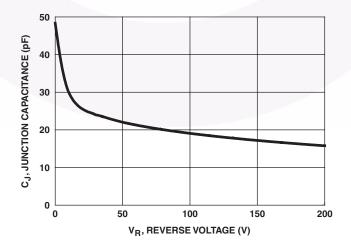


FIGURE 7. JUNCTION CAPACITANCE vs REVERSE VOLTAGE

## Test Circuits and Waveforms

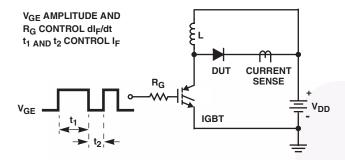


FIGURE 8. t<sub>rr</sub> TEST CIRCUIT

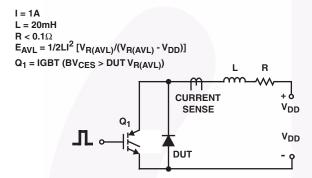


FIGURE 10. AVALANCHE ENERGY TEST CIRCUIT

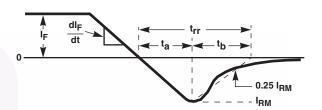


FIGURE 9. t<sub>rr</sub> WAVEFORMS AND DEFINITIONS

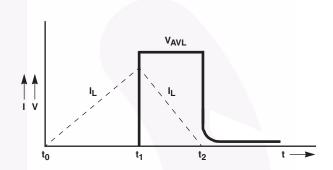


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

## **Mechanical Dimensions**

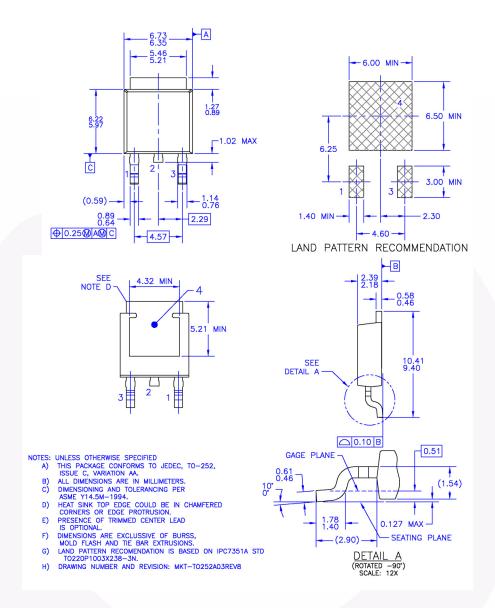


Figure 9. TO-252 3L (DPAK) - TO252 (D-PAK), MOLDED, 3 LEAD, OPTION AA&AB

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Rev. 166

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## Contact Us:

## > Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

## > Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

## Customer Service :

Email service@ameya360.com

# Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com